

TEMIC

Siliconix

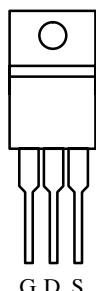
SMP60N03-10L

N-Channel Enhancement-Mode Transistor, Logic Level

Product Summary

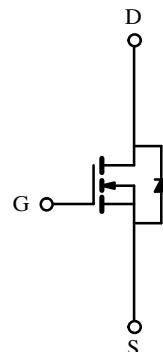
| $V_{(BR)DSS}$ (V) | $r_{DS(on)}$ (Ω) | I_D (A) |
|-------------------|---------------------------|-----------|
| 30 | 0.01 | 60 |

TO-220AB



DRAIN connected to TAB

Top View



N-Channel MOSFET

Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$ Unless Otherwise Noted)

| Parameter | Symbol | Limit | Unit |
|--|----------------|------------|------------------|
| Drain-Source Voltage | V_{DS} | 30 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | |
| Continuous Drain Current | I_D | 60 | A |
| | | 51 | |
| Pulsed Drain Current | I_{DM} | 240 | A |
| Avalanche Current | I_{AR} | 60 | |
| Avalanche Energy | E_{AS} | 180 | mJ |
| Repetitive Avalanche Energy ^a | E_{AR} | 90 | |
| Power Dissipation | P_D | 105 | W |
| | | 42 | |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | -55 to 150 | $^\circ\text{C}$ |
| Lead Temperature (1/16" from case for 10 sec.) | T_L | 300 | |

Thermal Resistance Ratings

| Parameter | Symbol | Typical | Maximum | Unit |
|---------------------|------------|---------|---------|---------------------------|
| Junction-to-Ambient | R_{thJA} | 80 | 1.2 | $^\circ\text{C}/\text{W}$ |
| Junction-to-Case | R_{thJC} | | | |
| Case-to-Sink | R_{thCS} | | | |

Notes:

a. Duty cycle $\leq 1\%$

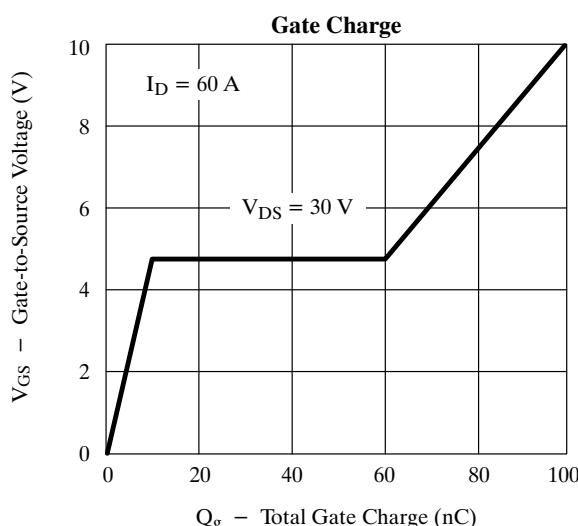
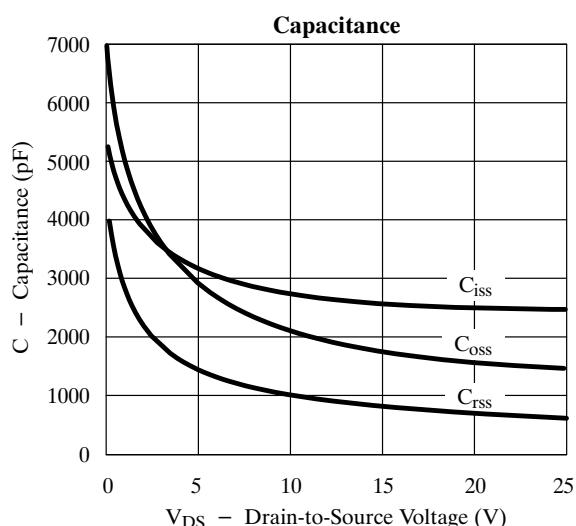
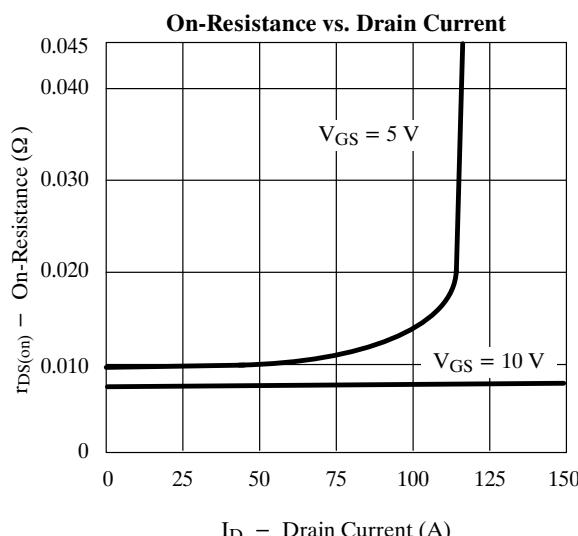
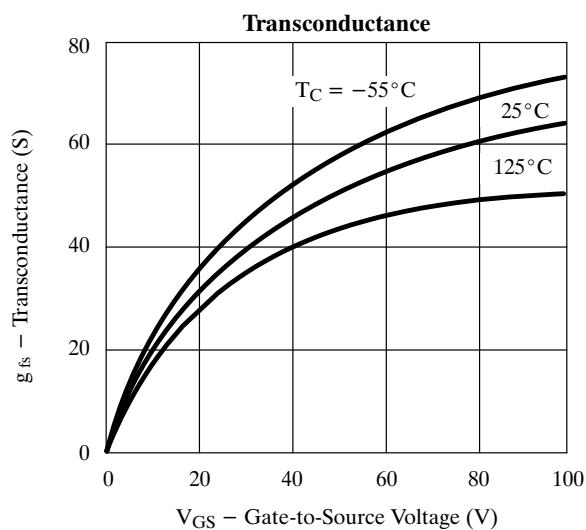
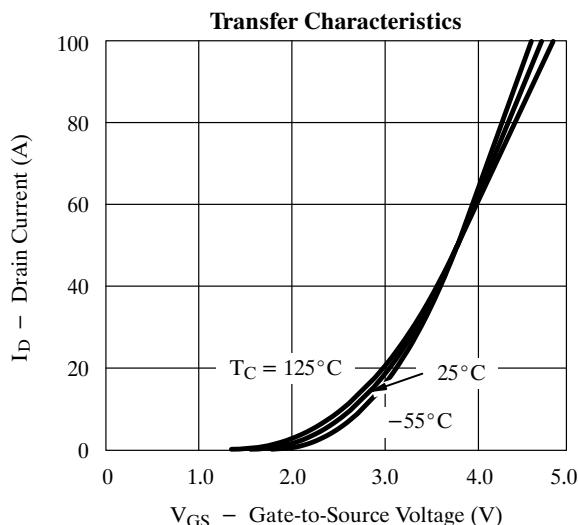
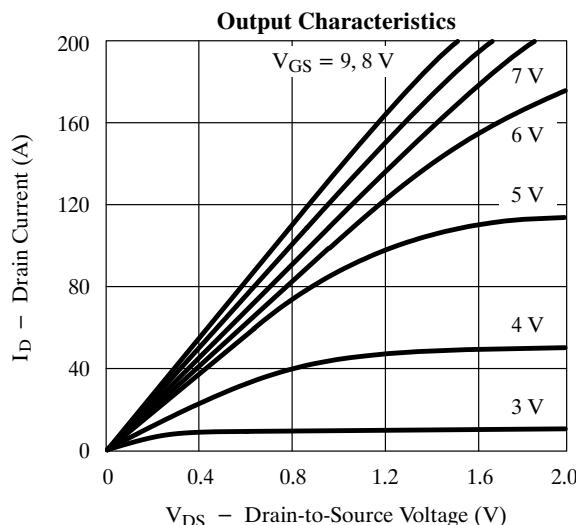
Specifications ($T_J = 25^\circ\text{C}$ Unless Otherwise Noted)

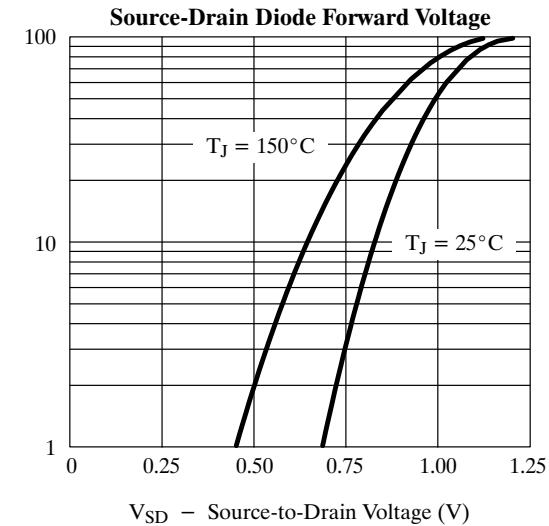
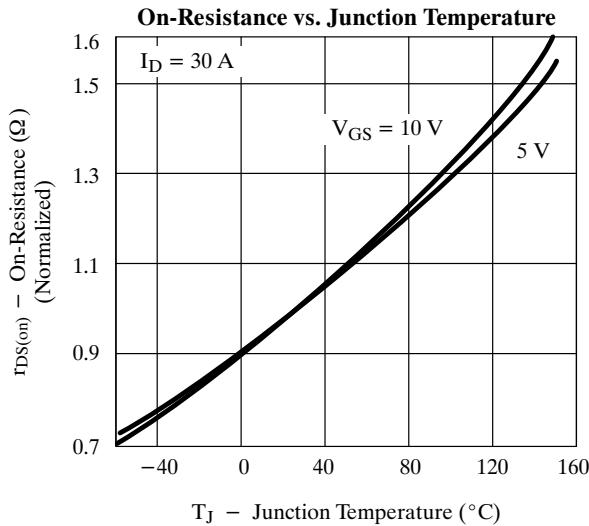
| Parameter | Symbol | Test Condition | Min | Typ ^a | Max | Unit |
|---|-----------------------------|---|-----|------------------|-----------|---------------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 30 | | | V |
| Gate Threshold Voltage | $V_{GS(\text{th})}$ | $V_{DS} = V_{GS}, I_D = 1 \text{ mA}$ | 0.8 | | 3.0 | |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 500 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 25 | μA |
| | | $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125^\circ\text{C}$ | | | 250 | |
| On-State Drain Current ^b | $I_{D(\text{on})}$ | $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}$ | 60 | | | A |
| Drain-Source On-State Resistance ^b | $r_{DS(\text{on})}$ | $V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$ | | 0.007 | 0.010 | Ω |
| | | $V_{GS} = 5 \text{ V}, I_D = 30 \text{ A}$ | | 0.010 | 0.015 | |
| | | $V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125^\circ\text{C}$ | | 0.009 | 0.014 | |
| Forward Transconductance ^b | g_{fs} | $V_{DS} = 15 \text{ V}, I_D = 30 \text{ A}$ | | 45 | | S |
| Dynamic | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 2600 | | pF |
| Output Capacitance | C_{oss} | | | 1500 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 750 | | |
| Total Gate Charge ^c | Q_g | $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$ | | 100 | 120 | nC |
| Gate-Source Charge ^c | Q_{gs} | | | 10 | 15 | |
| Gate-Drain Charge ^c | Q_{gd} | | | 45 | 75 | |
| Turn-On Delay Time ^c | $t_{d(on)}$ | $V_{DD} = 30 \text{ V}, R_L = 1 \Omega$ $I_D = 30 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$ | | 14 | 30 | ns |
| Rise Time ^c | t_r | | | 25 | 50 | |
| Turn-Off Delay Time ^c | $t_{d(off)}$ | | | 65 | 100 | |
| Fall Time ^c | t_f | | | 45 | 80 | |
| Source-Drain Diode Ratings and Characteristics ($T_C = 25^\circ\text{C}$) | | | | | | |
| Continuous Current | I_S | $I_F = 60 \text{ A}, V_{GS} = 0 \text{ V}$ | | | 60 | A |
| Pulsed Current | I_{SM} | | | | 240 | |
| Forward Voltage ^b | V_{SD} | $I_F = 60 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$ | | | 1.6 | V |
| Reverse Recovery Time | t_{rr} | | | | 160 | ns |
| Peak Reverse Recovery Current | $I_{RM(\text{REC})}$ | | | | 13 | |
| Reverse Recovery Charge | Q_{rr} | | | | 1.0 | μC |

Notes:

- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- c. Independent of operating temperature.

Typical Characteristics (25°C Unless Otherwise Noted)



SMP60N03-10L**Typical Characteristics (25°C Unless Otherwise Noted)****Thermal Ratings**